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Microsemi

MAX3624A

General Description

The MAX3624A is a low-jitter, precision clock generator optimized for networking applications. The device integrates a crystal oscillator and a phase-locked loop (PLL) clock multiplier to generate high-frequency clock outputs for Ethernet, Fibre Channel, SONET/SDH, and other networking applications.

This proprietary PLL design features ultra-low jitter (0.36psRMS) and excellent power-supply noise rejection, minimizing design risk for network equipment.

The MAX3624A has three LVPECL outputs and one LVCMOS output. Selectable output dividers and a selectable feedback divider allow a range of output frequencies.

Applications

Ethernet Networking Equipment

Fibre Channel Storage Area Network

SONET/SDH Network

Pin Configuration and Typical Application Circuit appear at end of data sheet.

Features

♦ **Crystal Oscillator Interface: 19.375MHz to 27MHz**

♦ **CMOS Input: 19MHz to 40.5MHz**

♦ **Output Frequencies**
  Ethernet: 62.5MHz, 125MHz, 156.25MHz, 312.5MHz
  Fibre Channel: 106.25MHz, 159.375MHz, 212.5MHz, 318.75MHz
  SONET/SDH: 77.76MHz, 155.52MHz, 311.04MHz

♦ **Low Jitter**
  0.14ps$_{RMS}$ (1.875MHz to 20MHz)
  0.36ps$_{RMS}$ (12kHz to 20MHz)

♦ **Excellent Power-Supply Noise Rejection**

♦ **No External Loop Filter Capacitor Required**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX3624AETJ+	-40°C to +85°C	32 TQFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.
*EP = Exposed pad.

Block Diagram

DIVIDERS:
M = 16, 24, 25, 32
NA = 1, 2, 3, 4, 5, 6, 8, 10, 12
NB = 1, 2, 3, 4, 5, 6, 8, 10, 12
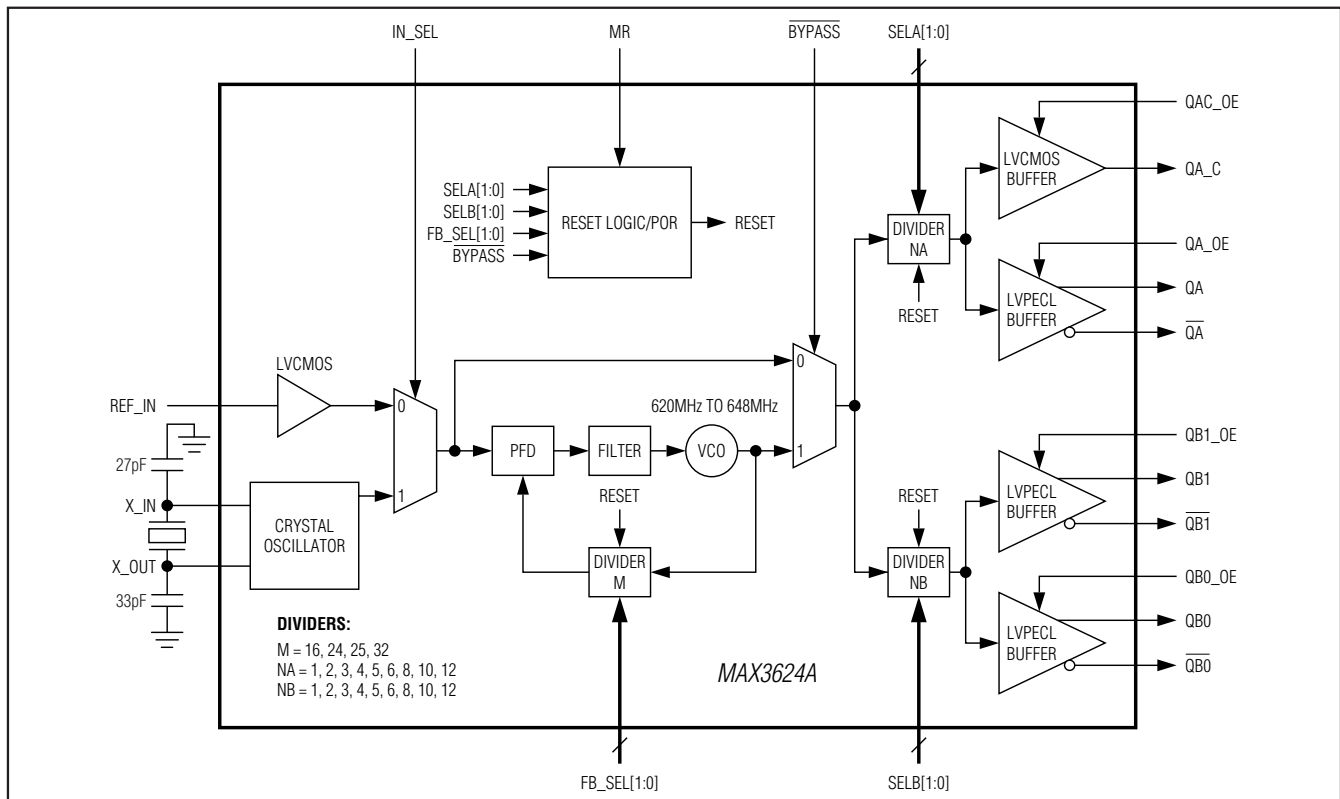
Low-Jitter, Precision Clock Generator with Four Outputs

ABSOLUTE MAXIMUM RATINGS

Supply Voltage Range V_{CC}, V_{CCA},
  V_{DDO_A}, V_{CCO_A}, V_{CCO_B} ....-0.3V to +4.0V
Voltage Range at REF_IN, IN_SEL,
  FB_SEL[1:0], SELA[1:0], SELB[1:0],
  QAC_OE, QA_OE, QB0_OE, QB1_OE,
  MR, $\overline{BYPASS}$ ....-0.3V to (V_{CC} + 0.3V)
Voltage Range at X_IN ....-0.3V to +1.2V

Voltage Range at GNDO_A ....-0.3V to +0.3V
Voltage Range at X_OUT ....-0.3V to (V_{CC} - 0.6V)
Current into QA_C ....±50mA
Current into QA, $\overline{QA}$, QB0, $\overline{QB0}$, QB1, $\overline{QB1}$ ....-56mA
Continuous Power Dissipation (T_A = +70°C)
  32-Pin TQFN (derate 34.5mW/°C above +70°C) 2759mW
Operating Junction Temperature Range ....-55°C to +150°C
Storage Temperature Range ....-65°C to +160°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = +3.0V to +3.6V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.3V, T_A = +25°C, unless otherwise noted.) (Notes 1, 2, and 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Power-Supply Current	I_{CC}	(Note 4)		82	100	mA
CONTROL INPUT CHARACTERISTICS **(SELA[1:0], SELB[1:0], FB_SEL[1:0], IN_SEL, QAC_OE, QA_OE, QB1_OE, QB0_OE, MR, $\overline{BYPASS}$ Pins)**						
Input Capacitance	C_{IN}			2		pF
Input Pulldown Resistor	$R_{PULLDOWN}$	Pins MR, FB_SEL[1:0]		75		kΩ
Input Logic Bias Resistor	R_{BIAS}	Pins SELA[1:0], SELB[1:0], QB0_OE		50		kΩ
Input Pullup Resistor	R_{PULLUP}	Pins QAC_OE, QA_OE, QB1_OE, IN_SEL, $\overline{BYPASS}$		75		kΩ
LVPECL OUTPUT SPECIFICATIONS (QA, $\overline{QA}$, QB0, $\overline{QB0}$, QB1, $\overline{QB1}$ Pins)						
Output High Voltage	V_{OH}		V_{CC} - 1.18	V_{CC} - 0.98	V_{CC} - 0.83	V
Output Low Voltage	V_{OL}		V_{CC} - 1.90	V_{CC} - 1.7	V_{CC} - 1.55	V
Peak-to-Peak Output-Voltage Swing (Single-Ended)		(Note 2)	0.6	0.72	0.9	V_{P-P}
Clock Output Rise/Fall Time		20% to 80% (Note 2)	200	350	600	ps
Output Duty-Cycle Distortion		PLL enabled	48	50	52	%
		PLL bypassed (Note 5)	45	50	55	
LVCMOS/LVTTL INPUT SPECIFICATIONS **(SELA[1:0], SELB[1:0], FB_SEL[1:0], IN_SEL, QAC_OE, QA_OE, QB1_OE, QB0_OE, MR, $\overline{BYPASS}$ Pins)**						
Input-Voltage High	V_{IH}		2.0			V
Input-Voltage Low	V_{IL}				0.8	V
Input High Current	I_{IH}	V_{IN} = V_{CC}			80	µA
Input Low Current	I_{IL}	V_{IN} = 0V	-80			µA

Low-Jitter, Precision Clock Generator with Four Outputs

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +3.0V to +3.6V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.3V, T_A = +25°C, unless otherwise noted.) (Notes 1, 2, and 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
REF_IN SPECIFICATIONS (Input DC- or AC-Coupled)						
Reference Clock Frequency		PLL enabled			40.5	MHz
		PLL bypassed			320	
Input-Voltage High	V_{IH}		2.0			V
Input-Voltage Low	V_{IL}				0.8	V
Input High Current	I_{IH}	V_{IN} = V_{CC}			240	µA
Input Low Current	I_{IL}	V_{IN} = 0V	-240			µA
Reference Clock Duty Cycle		PLL enabled	30		70	%
Input Capacitance				2.5		pF
QA_C SPECIFICATIONS						
Output High Voltage	V_{OH}	QA_C sourcing 12mA	2.6			V
Output Low Voltage	V_{OL}	QA_C sinking 12mA			0.4	V
Output Rise/Fall Time		(Notes 3 and 6)	250	500	1000	ps
Output Duty-Cycle Distortion		PLL enabled	42	50	58	%
		PLL bypassed (Note 5)	40	50	60	
Output Impedance				14		Ω
CLOCK OUTPUT AC SPECIFICATIONS						
VCO Frequency Range			620		648	MHz
Random Jitter (Note 7)	RJ_{RMS}	12kHz to 20MHz		0.36	1.0	ps_{RMS}
		1.875MHz to 20MHz		0.14		
Spurs Induced by Power-Supply Noise (Notes 8, 9, 10)		LVPECL output		-59		dBc
		LVCMOS output		-47		
Deterministic Jitter Induced by Power-Supply Noise		(Note 11)		4.6		ps_{P-P}
Nonharmonic and Subharmonic Spurs				-70		dBc
Output Skew		Between QB0 and QB1		15		ps
		Between QA and QB0 or QB1, PECL outputs		20		
Clock Output SSB Phase Noise at 125MHz (Note 12)		f = 1kHz		-124		dBc/Hz
		f = 10kHz		-125		
		f = 100kHz		-130		
		f = 1MHz		-145		
		f > 10MHz		-153		

Note 1: A series resistor of up to 10.5Ω is allowed between V_{CC} and V_{CCA} for filtering supply noise when system power-supply tolerance is V_{CC} = 3.3V ±5%. See Figure 2.
Note 2: Guaranteed up to 320MHz for LVPECL output.
Note 3: Guaranteed up to 160MHz for LVCMOS output.
Note 4: All outputs enabled and unloaded. IN_SEL set high.

Low-Jitter, Precision Clock Generator
with Four Outputs

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = +3.0V to +3.6V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V_{CC} = +3.3V, T_A = +25°C unless otherwise noted.) (Notes 1, 2, and 3)

Note 5: Measured with crystal or AC-coupled, 50% duty-cycle signal on REF_IN.
Note 6: Measured using setup shown in Figure 1 with V_{CC} = 3.3V ±5%.
Note 7: Measured with crystal source.
Note 8: Measured with 40mV$_{P-P}$, 100kHz sinusoidal signal on the supply.
Note 9: Measured at 156.25MHz output.
Note 10: Measured using setup shown in Figure 2.
Note 11: Calculated based on measured spurs induced by power-supply noise (refer to Application Note 4461: *HFAN-04.5.5: Characterizing Power-Supply Noise Rejection in PLL Clock Synthesizers*).
Note 12: Measured with 25MHz crystal or 25MHz reference clock at LVCMOS input with a slew rate of 0.5V/ns or greater.
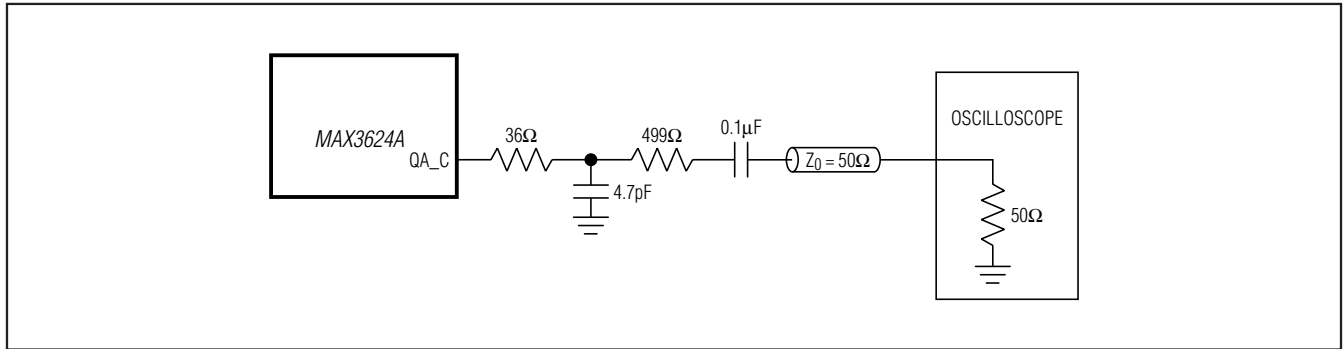
Figure 1. LVCMOS Output Measurement Setup

MAX3624A

(Typical values are at V_{CC} = +3.3V, T_A = +25°C, crystal frequency = 25MHz.)

**SUPPLY CURRENT
vs. TEMPERATURE**

MAX3624A toc01

ALL OUTPUTS ACTIVE AND TERMINATED

ALL OUTPUTS ACTIVE AND UNTERMINATED
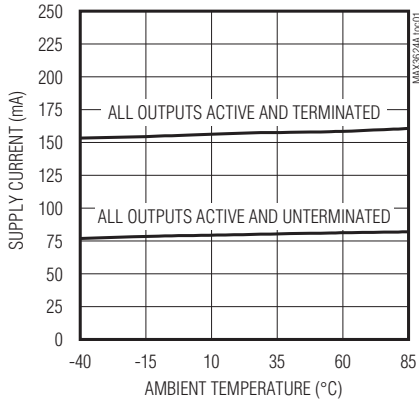
**DIFFERENTIAL OUTPUT WAVEFORM
AT 156.25MHz (LVPECL OUTPUT)**

MAX3624A toc02

1ns/div
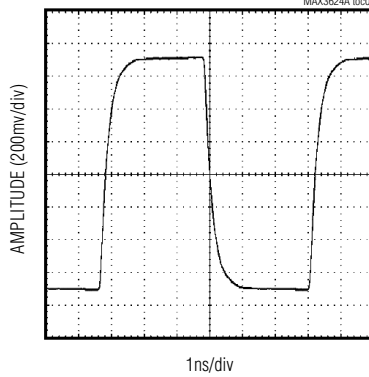
**OUTPUT WAVEFORM AT 125MHz
(LVCMOS OUTPUT)**

MAX3624A toc03

MEASURED USING 50Ω OSCILLOSCOPE INPUT
THROUGH NETWORK SHOWN IN FIGURE 1

1ns/div
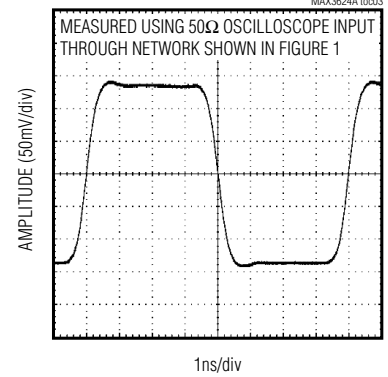
**PHASE NOISE AT 312.5MHz
CLOCK FREQUENCY**

MAX3624A toc04
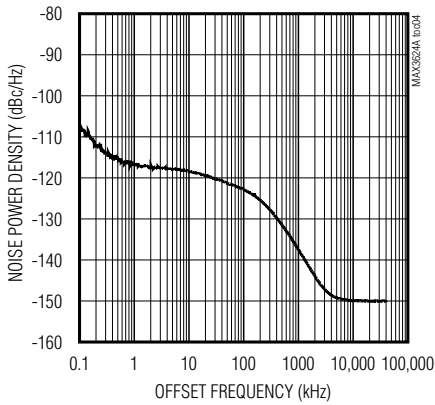
**PHASE NOISE AT 125MHz
CLOCK FREQUENCY**

MAX3624A toc05
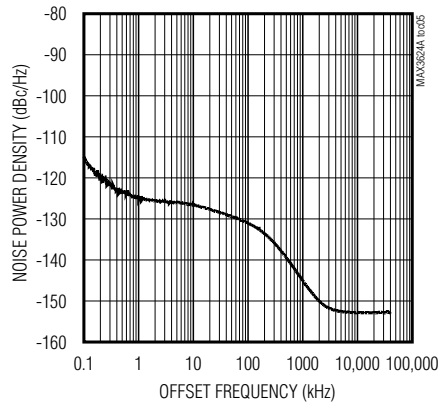
**PHASE NOISE AT 212.5MHz
CLOCK FREQUENCY
(26.5625MHz CRYSTAL)**

MAX3624A toc06
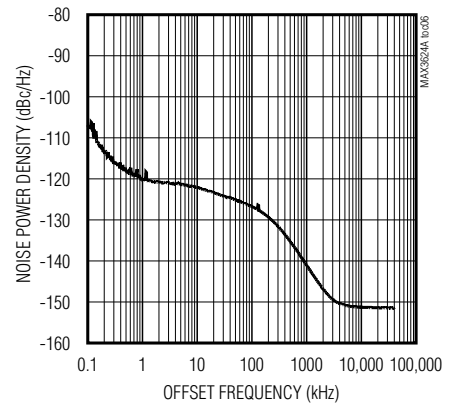
**NOISE SPUR AMPLITUDE
vs. NOISE FREQUENCY**
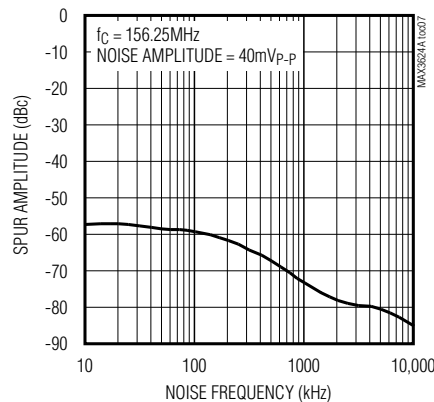
MAX3624A toc07

f_C = 156.25MHz
NOISE AMPLITUDE = 40mV$_{P-P}$

5

MAX3624A

PIN	NAME	FUNCTION
1	V$_{CCO\_B}$	Power Supply for QB0 and QB1 Clock Outputs. Connect to +3.3V.
2, 19, 24	GND	Supply Ground
3	QB0_OE	LVCMOS/LVTTL Input. Enables/disables QB0 clock output. Connect pin high to enable LVPECL clock output QB0. Connect low to set QB0 to a logic 0. Has internal 50kΩ input impedance.
4, 5	SELB1, SELB0	LVCMOS/LVTTL Input. Controls NB divider setting. Has 50kΩ input impedance. See Table 2 for more information.
6	QAC_OE	LVCMOS/LVTTL Input. Enables/disables QA_C clock output. Connect pin high to enable QA_C. Connect low to set QA_C to a high-impedance state. Has internal 75kΩ pullup to V$_{CC}$.
7	MR	LVCMOS/LVTTL Input. Master reset input. Pulse high for > 1µs to reset all dividers. Has internal 75kΩ pulldown to GND. Not required for normal operation.
8	GNDO_A	Ground for QA_C Output. Connect to supply ground.
9	QA_C	LVCMOS Clock Output
10	V$_{DDO\_A}$	Power Supply for QA_C Clock Output. Connect to +3.3V.
11	V$_{CCO\_A}$	Power Supply for QA Clock Output. Connect to +3.3V.
12	QA	Noninverting Clock Output, LVPECL
13	$\overline{QA}$	Inverting Clock Output, LVPECL
14	$\overline{BYPASS}$	LVCMOS/LVTTL Input (Active Low). Connect low to bypass the internal PLL. Connect high for normal operation. When in bypass mode the output dividers are set to divide by 1. Has internal 75kΩ pullup to V$_{CC}$.
15, 16	FB_SEL1, FB_SEL0	LVCMOS/LVTTL Input. Controls M divider setting. See Table 3 for more information. Has internal 75kΩ pulldown to GND.
17	V$_{CCA}$	Analog Power Supply for the VCO. Connect to +3.3V. For additional power-supply noise filtering, this pin can connect to V$_{CC}$ through 10.5Ω as shown in Figure 2 (requires V$_{CC}$ = +3.3V ±5%).
18	V$_{CC}$	Core Power Supply. Connect to +3.3V.
20	QA_OE	LVCMOS/LVTTL Input. Enables/disables the QA clock output. Connect this pin high to enable the LVPECL clock output QA. Connect low to set QA to a logic 0. Has internal 75kΩ pullup to V$_{CC}$.
21, 22	SELA0, SELA1	LVCMOS/LVTTL Input. Controls NA divider setting. See Table 2 for more information. Has 50kΩ input impedance.
23	QB1_OE	LVCMOS/LVTTL Input. Enables/disables QB1 clock output. Connect pin high to enable LVPECL clock output QB1. Connect low to set QB1 to a logic 0. Has internal 50kΩ input impedance.
25	X_OUT	Crystal Oscillator Output
26	X_IN	Crystal Oscillator Input
27	REF_IN	LVCMOS Reference Clock Input. Self-biased to allow AC- or DC-coupling.
28	IN_SEL	LVCMOS/LVTTL Input. Connect high or leave open to use a crystal. Connect low to use REF_IN. Has internal 75kΩ pullup to V$_{CC}$.
29	$\overline{QB1}$	LVPECL, Inverting Clock Output
30	QB1	LVPECL, Noninverting Clock Output
31	$\overline{QB0}$	LVPECL, Inverting Clock Output
32	QB0	LVPECL, Noninverting Clock Output
—	EP	Exposed Pad. Connect to supply ground for proper electrical and thermal performance.

Low-Jitter, Precision Clock Generator with Four Outputs

Detailed Description

The MAX3624A is a low-jitter clock generator designed to operate at Ethernet, Fibre Channel, and SONET/SDH frequencies. It consists of an on-chip crystal oscillator, PLL, programmable dividers, LVCMOS output buffer, and LVPECL output buffers. Using a low-frequency clock (crystal or CMOS input) as a reference, the internal PLL generates a high-frequency output clock with excellent jitter performance.

Crystal Oscillator

An integrated oscillator provides the low-frequency reference clock for the PLL. This oscillator requires an external crystal connected between X_IN and X_OUT. Crystal frequency is 19.375MHz to 27MHz.

REF_IN Buffer

An LVCMOS-compatible clock source can be connected to REF_IN to serve as the reference clock.

The LVCMOS REF_IN buffer is internally biased to allow AC- or DC-coupling. It is designed to operate up to 320MHz.

PLL

The PLL takes the signal from the crystal oscillator or reference clock input and synthesizes a low-jitter, high-frequency clock. The PLL contains a phase-frequency detector (PFD), a lowpass filter, and a voltage-controlled oscillator (VCO) with a 620MHz to 648MHz operating range. The VCO output is connected to the PFD input through a feedback divider. See Table 3 for divider values. The PFD compares the reference frequency to the divided-down VCO output (f_{VCO}/M) and generates a control signal that keeps the VCO locked to the reference clock. The high-frequency VCO output clock is sent to the output dividers. To minimize noise-induced jitter, the VCO supply (V_{CCA}) is isolated from the core logic and output buffer supplies.

Output Dividers

The output divider is programmable to allow a range of output frequencies. See Table 2 for the divider input settings. The output dividers are automatically set to divide by 1 when the MAX3624A is in bypass mode ($\overline{BYPASS}$ = 0).

LVPECL Drivers

The high-frequency outputs—QA, QB0, and QB1—are differential PECL buffers designed to drive transmission lines terminated with 50Ω to V_{CC} - 2.0V. The maximum operating frequency is specified up to 320MHz. Each output can be individually disabled, if not used. The outputs go to a logic 0 when disabled.

LVCMOS Driver

QA_C, the LVCMOS output, is designed to drive a single-ended high-impedance load. The maximum operating frequency is specified up to 160MHz. This output can be disabled by the QAC_OE pin if not used and goes to a high impedance when disabled.

Reset Logic/POR

During power-on, the power-on reset (POR) signal is generated to synchronize all dividers. An external master reset (MR) signal is not required.

Applications Information

Power-Supply Filtering

The MAX3624A is a mixed analog/digital IC. The PLL contains analog circuitry susceptible to random noise. In addition to excellent on-chip power-supply noise rejection, the MAX3624A provides a separate power-supply pin, V_{CCA}, for the VCO circuitry. Figure 2 illustrates the recommended power-supply filter network for V_{CCA}. The purpose of this design technique is to ensure clean input power supply to the VCO circuitry and to improve the overall immunity to power-supply noise. This network requires that the power supply is +3.3V ±5%. Decoupling capacitors should be used on all other supply pins for best performance.

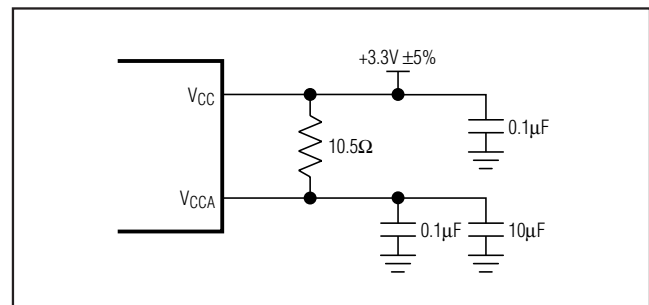Figure 2. Analog Supply Filtering

MAX3624A

Table 1. Output Frequency Determination

XO OR CMOS INPUT FREQUENCY (MHz)	FEEDBACK DIVIDER, M	VCO FREQUENCY (MHz)	OUTPUT DIVIDER, NA AND NB	OUTPUT FREQUENCY (MHz)	APPLICATIONS
25	25	625	÷2	312.5	Ethernet
			÷4	156.25	
			÷5	125	
			÷8	78.125	
			÷10	62.5	
25.78125	25	644.53125	÷4	161.132812	10Gbps Ethernet
26.04166	24	625	÷2	312.5	Ethernet
			÷4	156.25	
			÷5	125	
			÷8	78.125	
			÷10	62.5	
26.5625	24	637.5	÷2	318.75	Fibre Channel
			÷3	212.5	
			÷4	159.375	
			÷6	106.25	
			÷12	53.125	
19.44	32	622.08	÷2	311.04	SONET/SDH
			÷4	155.52	
			÷8	77.76	
38.88 (CMOS input)	16	622.08	÷2	311.04	SONET/SDH
			÷4	155.52	
			÷8	77.76	

Output Divider Configuration

Table 2 shows the input settings required to set the output dividers. Leakage in the open case must be less than 1µA. Note that when the MAX3624A is in bypass mode (BYPASS set low), the output dividers are automatically set to divide by 1.

Table 2. Output Divider Configuration

INPUT		NA/NB DIVIDER
SELA1/SELB1	SELA0/SELB0	
0	0	÷2*
0	1	÷3*
1	0	÷4
1	1	÷5
1	Open	÷6
Open	1	÷8
0	Open	÷10
Open	0	÷12
Open	Open	÷1*

Maximum guaranteed output frequency is 160MHz for CMOS and 320MHz for LVPECL output.

Low-Jitter, Precision Clock Generator with Four Outputs

PLL Divider Configuration

Table 3 shows the input settings required to set PLL feedback divider.

Crystal Selection

The crystal oscillator is designed to drive a fundamental mode, AT-cut crystal resonator. See Table 4 for recommended crystal specifications. See Figure 4 for external capacitance connection.

Crystal Input Layout and Frequency Stability

The crystal, trace, and two external capacitors should be placed on the board as close as possible to the MAX3624A's X_IN and X_OUT pins to reduce crosstalk of active signals into the oscillator.

The layout shown in Figure 3 gives approximately 3pF of trace plus footprint capacitors per side of the crystal (Y1). The dielectric material is FR4 and dielectric thickness of the reference board is 15 mils. Using a 25MHz crystal and the capacitor values of C22 = 27pF and C23 = 33pF, the measured output frequency accuracy is -14ppm at +25°C ambient temperature.

Table 3. PLL Divider Configuration Chart

INPUT		M DIVIDER
FB_SEL1	FB_SEL0	
0	0	÷25
0	1	÷24
1	0	÷32
1	1	÷16

Table 4. Crystal Selection Parameters

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS
Crystal Oscillation Frequency	f_{OSC}	19.375		27	MHz
Shunt Capacitance	C_O		2.0	7.0	pF
Load Capacitance	C_L		18		pF
Equivalent Series Resistance (ESR)	R_S			50	Ω
Maximum Crystal Drive Level				300	µW
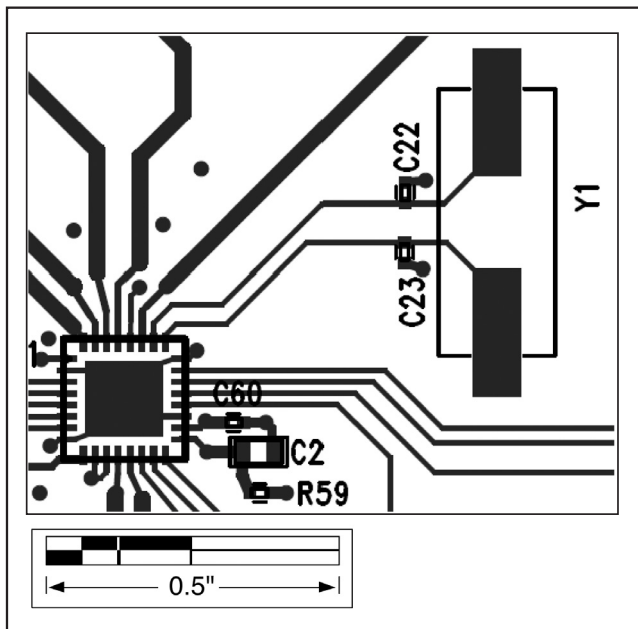
Figure 3. Crystal Layout
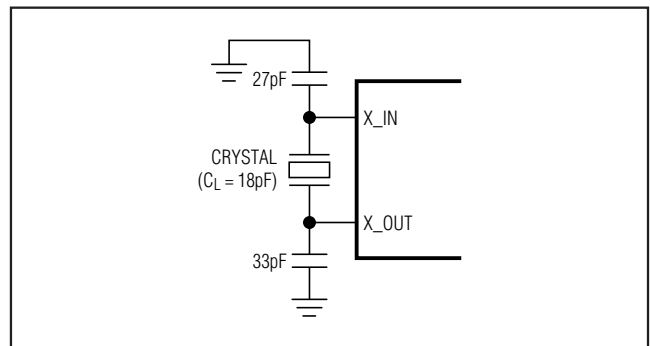
Figure 4. Crystal, Capacitors Connection

Low-Jitter, Precision Clock Generator with Four Outputs

Interfacing with LVPECL Outputs

The equivalent LVPECL output circuit is given in Figure 8. These outputs are designed to drive a pair of 50Ω transmission lines terminated with 50Ω to V_{TT} = V_{CC} - 2V. If a separate termination voltage (V_{TT}) is not available, other termination methods can be used such as shown in Figure 5 and Figure 6. Unused outputs should be disabled and may be left open. For more information on LVPECL terminations and how to interface with other logic families, refer to Application Note 291: *HFAN-01.0: Introduction to LVDS, PECL, and CML.*
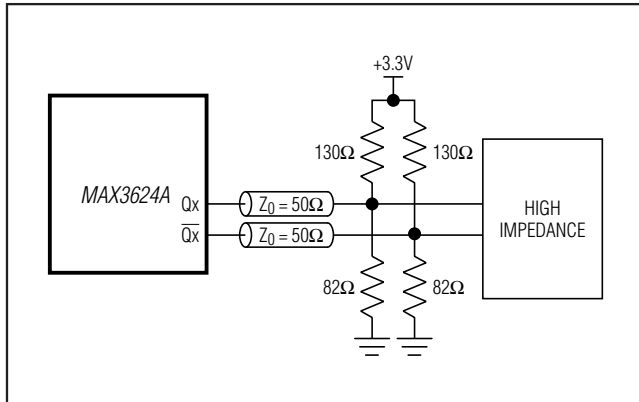
Figure 5. Thevenin Equivalent of Standard PECL Termination

NOTE: AC-COUPLING IS OPTIONAL.
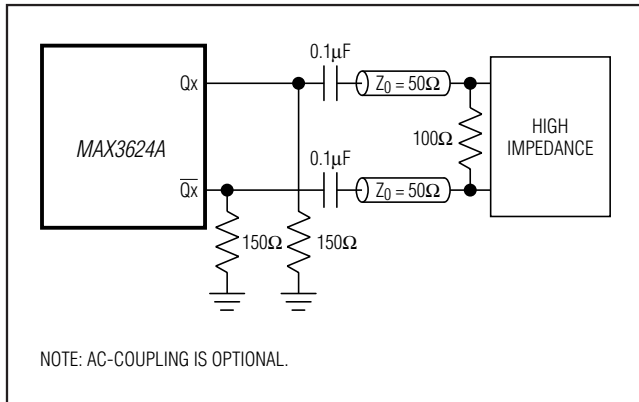
Figure 6. AC-Coupled PECL Termination

Interface Models

Figure 7, Figure 8, and Figure 9 show examples of interface models.
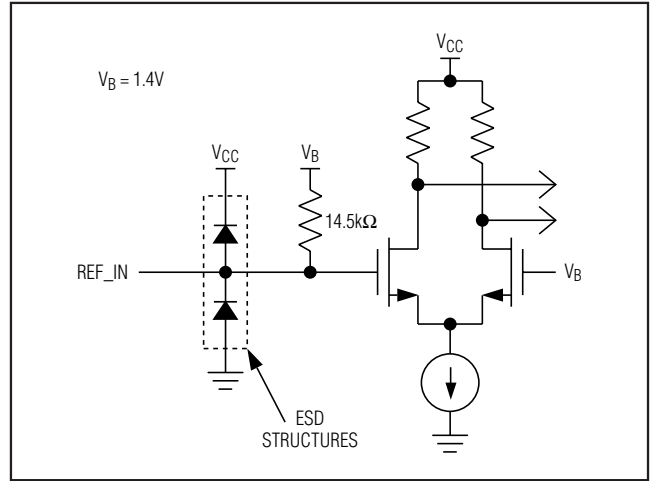
Figure 7. Simplified REF_IN Pin Circuit Schematic
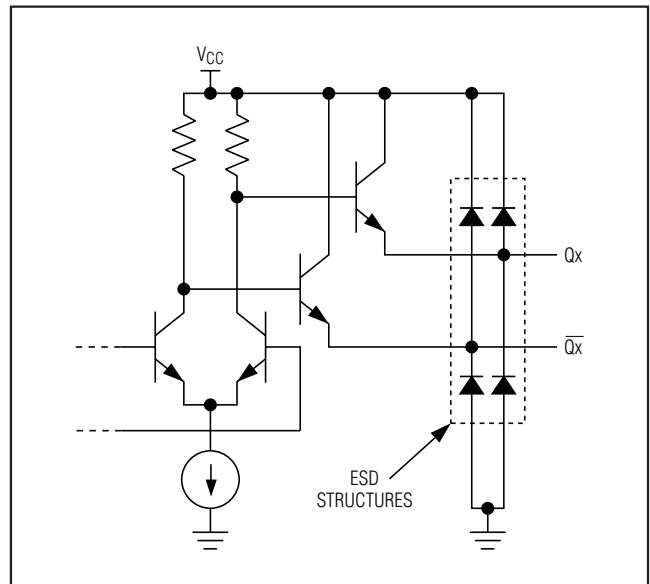
Figure 8. Simplified LVPECL Output Circuit Schematic
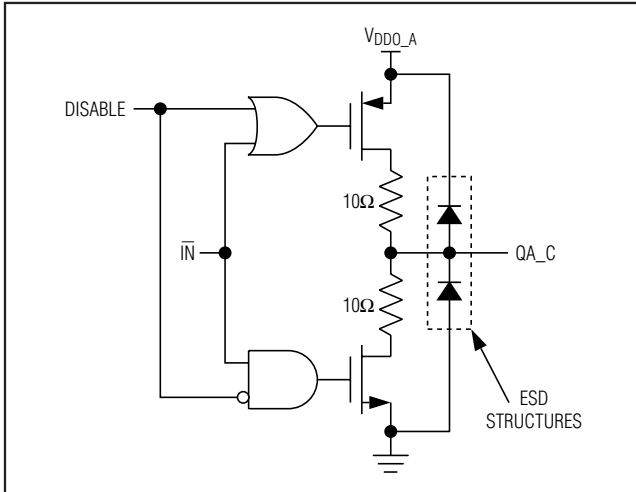
MAX3624A

Figure 9. Simplified LVCMOS Output Circuit Schematic

Layout Considerations

The inputs and outputs are critical paths for the MAX3624A, and care should be taken to minimize discontinuities on these transmission lines. Here are some suggestions for maximizing the MAX3624A's performance:

- An uninterrupted ground plane should be positioned beneath the clock I/Os.

- Ground pin vias should be placed close to the IC and the input/output interfaces to allow a return current path to the MAX3624A and the receive devices.

- Supply decoupling capacitors should be placed close to the MAX3624A supply pins.

- Maintain 100Ω differential (or 50Ω single-ended) transmission line impedance out of the MAX3624A.

- Use good high-frequency layout techniques and a multilayer board with an uninterrupted ground plane to minimize EMI and crosstalk.

Refer to the MAX3624A Evaluation Kit for more information.

Exposed-Pad Package

The exposed pad on the 32-pin TQFN package provides a very low inductance path for return current traveling to the PCB ground plane. The pad is also electrical ground on the MAX3624A and must be soldered to the circuit board ground for proper electrical performance.
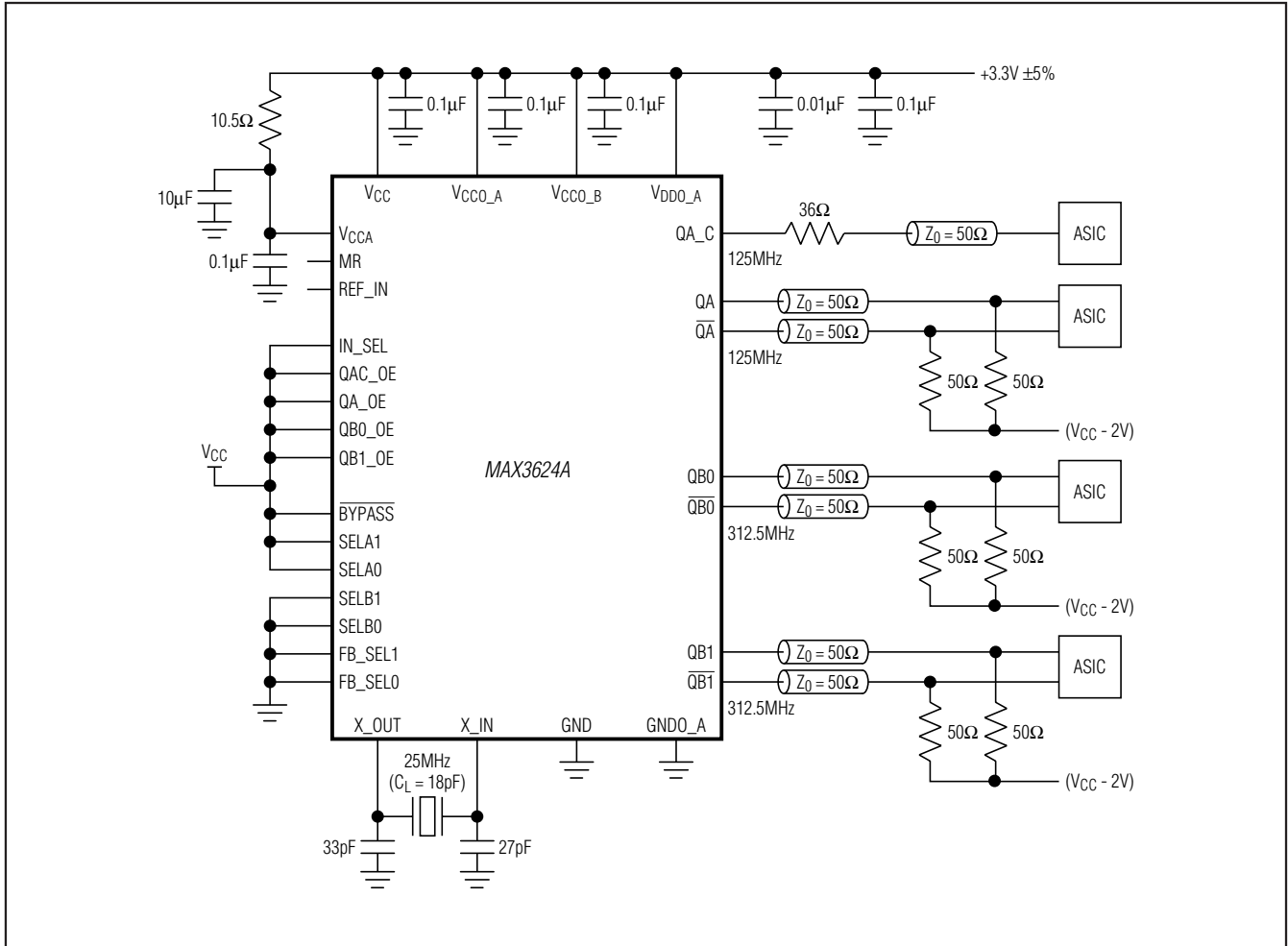
Pin Configuration

THIN QFN
(5mm × 5mm)

*EXPOSED PAD CONNECTED TO GROUND.
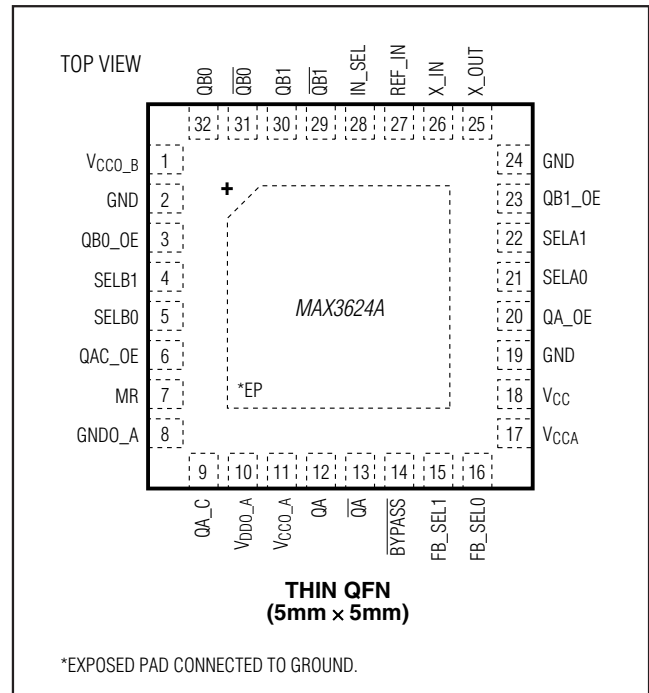
Chip Information

TRANSISTOR COUNT: 10,780
PROCESS: BiCMOS

Low-Jitter, Precision Clock Generator with Four Outputs

For the latest package outline information and land patterns, go to www.microsemi.com. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
32 TQFN-EP	T3255+3	**21-0140**